



DMC3028LSDX

COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
04 201/		$27m\Omega$ @ $V_{GS} = 10V$	7.2A
Q1	30V	$35m\Omega$ @ $V_{GS} = 4.5V$	6.0A
Q2	-30V	$25m\Omega$ @ $V_{GS} = -10V$	-7.6A
		$41m\Omega$ @ $V_{GS} = -4.5V$	-6.2A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions
- Backlighting

Features and Benefits

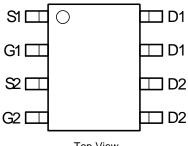
- Low Input Capacitance
- Low On-Resistance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMC3028LSDXQ</u>)

Mechanical Data

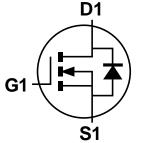
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)







Top View Pin Configuration





G2

Q N-Channel MOSFET

Q2 P-Channel MOSFET

S2

D2

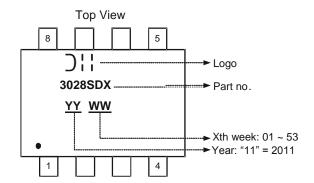
Ordering Information (Note 4)

Part Number	Case	Packaging
DMC3028LSDX-13	SO-8	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





Maximum Ratings - Q1 and Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1	Q2	Units		
Drain-Source Voltage	V _{DSS}	30	-30	V		
Gate-Source Voltage			V _{GSS}	±20	±20	V
Ster Ste		T _A = +25°C T _A = +70°C	I _D	5.5 4.1	-5.8 -4.3	А
Continuous Drain Current (Note 5) V _{GS} =10V	t<10s	T _A = +25°C T _A = +70°C	I _D	7.2 5.7	-7.6 -6.1	А
Maximum Body Diode Forward Current (Note 5)		Is	2.2	-2.2	Α	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	40	-30	Α		
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	14.5	-22	Α		
Avalanche Energy (Note 7) L = 0.1mH			Eas	10.5	25	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Dawar Dissination (Note 5)	$T_A = +25^{\circ}C$	Б	1.2	W
Total Power Dissipation (Note 5)	T _A = +70°C	P_{D}	0.75	
Thormal Pagistance, Junction to Ambient (Note 5)	Steady state	D.	108	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	65	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	р	1.5	W
Total Fower Dissipation (Note 0)	$T_A = +70^{\circ}C$	P_{D}	0.95	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	<u> </u>	85	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	50	
Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	14.5		
Operating and Storage Temperature Range		$T_{J_1}T_{STG}$	-55 to +150	°C

Electrical Characteristics - Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 24V, V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 8)	ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(th)}	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$		
Static Drain-Source On-Resistance	ם		19	27	mΩ	$V_{GS} = 10V, I_D = 6A$		
Static Drain-Source On-Resistance	R _{DS (ON)}	_	22	35	11122	$V_{GS} = 4.5V, I_D = 5A$		
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1.3A$		
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance	Ciss		641			V _{DS} = 15V, V _{GS} = 0V f = 1.0MHz		
Output Capacitance	Coss		66	_	pF			
Reverse Transfer Capacitance	Crss		51	_				
Gate Resistance	R_{G}		2.2	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$		
Total Gate Charge (V _{GS} = 4.5V)	Q_g		6	_		V _{DS} = 15V, I _D = 10A		
Total Gate Charge (V _{GS} = 10V)	Q_g		13.2	_	nC			
Gate-Source Charge	Q_{gs}		1.7	_	IIC			
Gate-Drain Charge	Q_{gd}	_	2.2	_				
Turn-On Delay Time	t _{D(on)}	_	3.3	_		$V_{GS} = 10V, V_{DD} = 15V, R_G = 6\Omega,$		
Turn-On Rise Time	t _r		4.4	_	nS			
Turn-Off Delay Time	t _{D(off)}	_	22.3		113	I _D = 1A		
Turn-Off Fall Time	t _f		5.3					

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 5. Device mounted on FR-4 substrate PC board, 202 copper, with minimum recommended particles.
 6. Device mounted on FR-4 substrate PC board, 202 copper, with 1inch square copper plate.
 7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C.
 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to product testing.



Electrical Characteristics - Q2 (@T_A = +25°C, unless otherwise specified.)

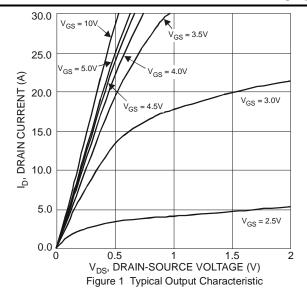
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_		V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(th)}	-1	_	-3	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance	В	_	21	25	0	$V_{GS} = -10V, I_D = -6A$	
Static Drain-Source On-Resistance	R _{DS (ON)}	_	29	41	mΩ	$V_{GS} = -4.5V, I_{D} = -5A$	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1.3A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	1,241	_		$V_{DS} = -15V, V_{GS} = 0V$ f = 1.0MHz	
Output Capacitance	Coss	_	146	_	pF		
Reverse Transfer Capacitance	Crss	_	110	_			
Gate Resistance	R _G	_	14.8	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	10.9	_		V _{DS} = -15V, I _D = -7A	
Total Gate Charge (V _{GS} = -10V)	Qg	_	22	_	nC		
Gate-Source Charge	Q _{gs}	_	3.5	_	IIC		
Gate-Drain Charge	Q _{gd}	_	4.7	_			
Turn-On Delay Time	t _{D(on)}	_	9.7	_		$V_{GS} = -10V, V_{DD} = -15V, R_{GEN} = 6\Omega,$	
Turn-On Rise Time	t _r	_	17.1	_			
Turn-Off Delay Time	t _{D(off)}	_	60.5	_	nS	I _D = -7A	
Turn-Off Fall Time	t _f	_	40.4	_			

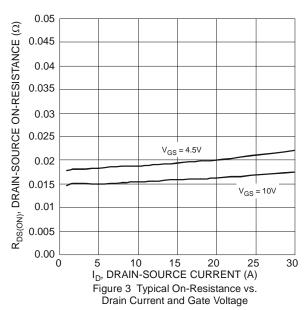
Notes:

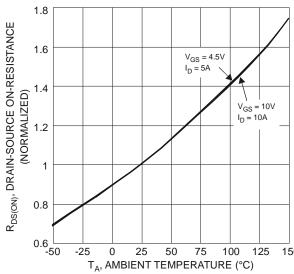
^{8.} Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.

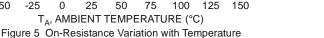


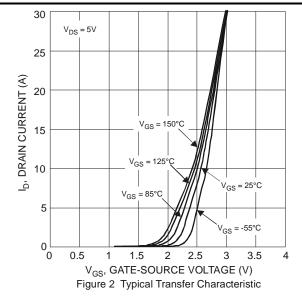
N-Channel - Q1

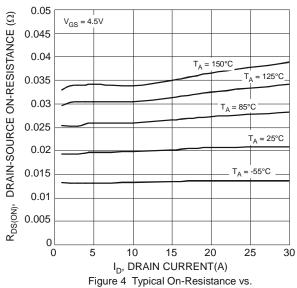












Drain Current and Temperature

0.04 $R_{DS(ON)}$, DRAIN-SOURCE ON-RESISTANCE (Ω) 0.035 V_{GS} = 4.5V 0.03 $I_D = 5A$ 0.025 $V_{GS} = 10V$ I_D = 10A 0.02 0.015 0.01 0.005 -50 0 25 50 75 100 125 T_A, AMBIENT TEMPERATURE (°C)



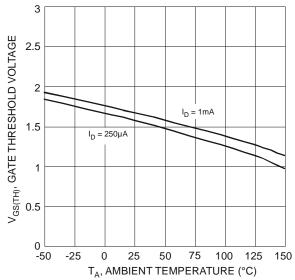


Figure 7 Gate Threshold Variation vs. Ambient Temperature

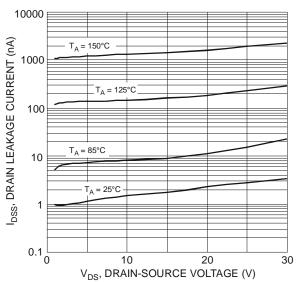


Figure 9 Typical Drain-Source Leakage Current vs. Voltage

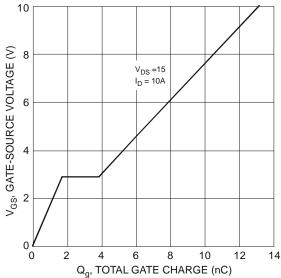
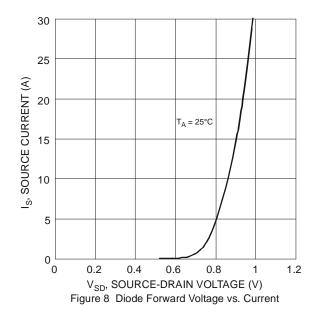
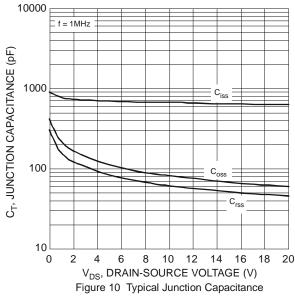
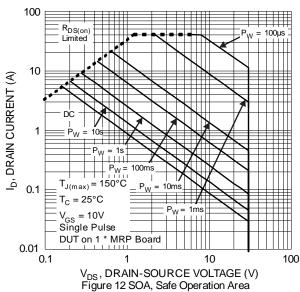


Figure 11 Gate-Source Voltage vs. Total Gate Charge

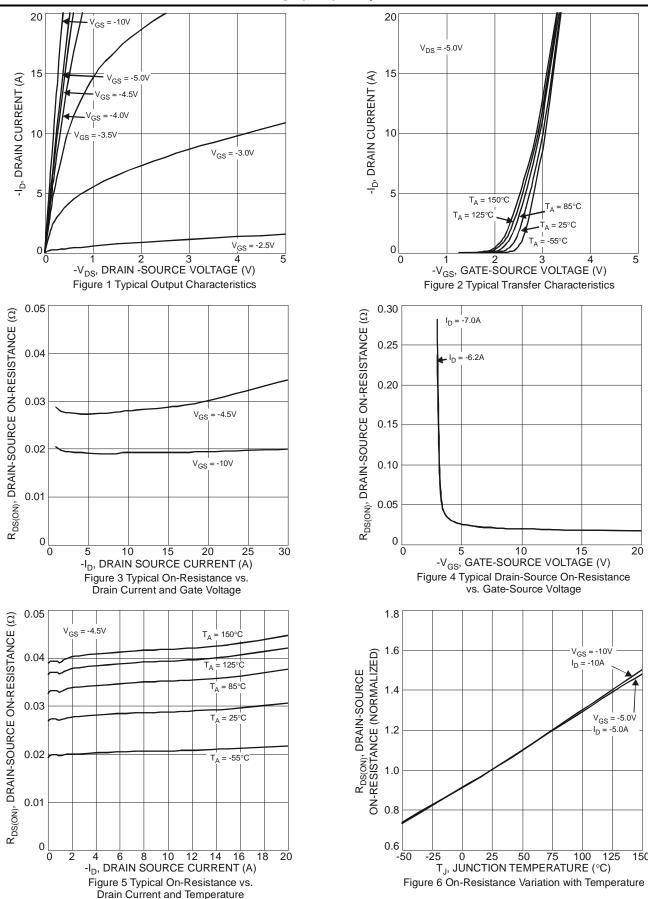




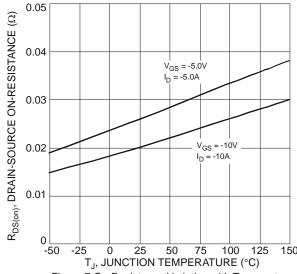


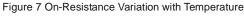


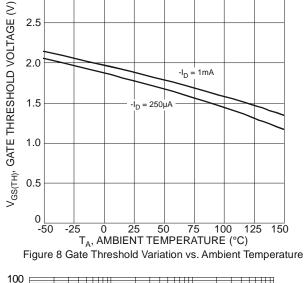
P-Channel - Q2











3.0



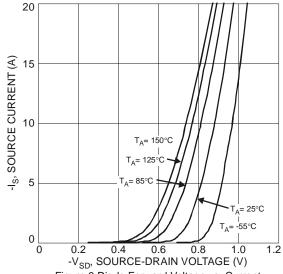
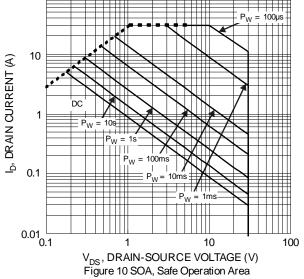


Figure 9 Diode Forward Voltage vs. Current



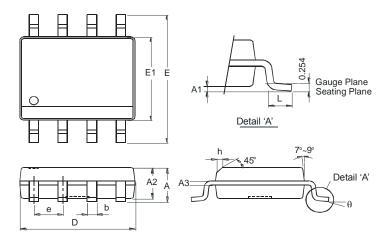
r(t), TRANSIENT THE RMAL RESISTANCE D = 0.30.1 D = 0.1 0.01 -D = 0.01 0.005 $R_{\theta JA}(t) = r(t) * R_{\theta JA}$ $R_{\theta JA} = 113^{\circ}C/W$ Duty Cycle, D = t1/t2 D= 0.001 0.00001 0.0001 0.001 0.01 0.1 1 10 100 1000 t1, PULSE DURATION TIME (sec)

Figure 13 Transient Thermal Resistance



Package Outline Dimensions

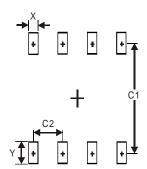
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SO-8							
Dim	Min	Max						
Α	-	1.75						
A1	0.10	0.20						
A2	1.30	1.50						
A3	0.15	0.25						
b	0.3	0.5						
D	4.85	4.95						
Е	5.90	6.10						
E1	3.85	3.95						
е	e 1.27 Typ							
h	-	0.35						
L	0.62	0.82						
Θ	0°	8°						
All Dimensions in mm								

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)				
X	0.60				
Y	1.55				
C1	5.4				
C2	1 27				



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